	08-05-1998 H-480-FWC				
MR	D 7 - 29 - 98 H-480 - FWC				
PAT	ENTS ONLY (ref OG 7/28/92) 100784398				
To the Honorable Commissioner of Patents and Trademarks: Please record the attached original document or copy thereof. 1. Mark Name of Party(ies) conveying an 2. Name and Address of Party(ies) interest: receiving an interest:					
3.	Description of the interest conveyed: <u>Assignment</u>				
4.	4. Application number(s) or patent number(s).				
	Additional sheet attached? Yes XXX No				
If this document is being filed together with a new application, the execution date of the application is:					
Α.	Patent Application No.(s) B. Patent No.(s)				
	08/857,167				
Ľ.,	. Name and address of party to whom correspondence concerning document should be mailed:				
Thomas E. Beall, Jr. Fay, Sharpe, Beall, Fagan, Minnich & McKee 104 East Hume Avenue Alexandria, Virginia 22301					
6.	6. Number of applications and patents involved: One				
7.	. Amount of fee enclosed or authorized to be charged: <u>\$40.00</u>				
8.	The Commissioner is hereby authorized to charge Deposit Account No. 02-1540 if no check is attached				
DO NOT USE THIS SPACE 9. Execution date of attached document: June 27, 1995					
					10.
08/03/1998 DNGUYEN 00000117 08857167					
01 FLISAL Name of Person Signing Signature July 29, 1998 Date					

Total number of pages being submitted: 1

ASSIGNMENT (譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by HITACHI, LTD., a corporation organized under the laws of Japan, located at 6, Kanda Surugadai 4-chome, Chiyoda-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said HITACHI, LTD., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

SEMICONDUCTOR INTEGRATED CIRCUIT ARRANGEMENT FABRICATION METHOD U.S.Patent Application Serial No. filed on June 7, 1995

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said HITACHI, LTD., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI, LTD.

Signed on the date(s) indicated aside signatures :

	INVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)	Witnesses (立会人サイン)
1)	Takatumi Tukunaga	June 27, 1995	Akihiko Konno
2)	Takafumi TOKUNAGA Sadayu ni (⁴ kudaina <u>)</u> Sadayuki OKUDAIRA	June 27, 1995.	Masctome Xanegae
3)	Tatsumi Mizatami	June 27, 1995	Jutaka Omoto
4)	Tatsumi MIZUTANI Hazutanu Tagu- Kazutami TABO	June 27, 1995	plinga Morajadin
5)	Hideyake Mazumi	June 27, 1995	Atsushi Chitake
6)	Hidéyuki KAZUMI Ken Yoshicka Ken Yoshioka	June 27, 1995	Minole Sorreplan
7)			
8)			
9)		-	
10)			

RECORDED: 07/29/1998

PATENT REEL: 9353 FRAME: 0161